

Title (en)
Package suitable for microwave

Title (de)
Mikrowellengeeignete Verpackung

Title (fr)
Emballage adaptée pour micro-onde

Publication
EP 1714908 A3 20061108 (DE)

Application
EP 06008047 A 20060419

Priority
AT 6722005 A 20050421

Abstract (en)
[origin: EP1714908A2] Packaging for heating in a microwave oven, oven or in a water bath comprises an outer layer having an energy-absorbing layer in the region defined by the recess of an inner layer and/or in the region surrounding the recess. An independent claim is also included for a film material used for producing the packaging. Preferred Features: Recesses extend from edge to edge of the packaging, preferably only in defined regions of the packaging. A protective seal is provided around the recesses. Intermediate layers, preferably barrier layers, absorber layers or browning layers, are arranged between the inner and outer layers.

IPC 8 full level
B65D 77/22 (2006.01); **B65D 81/32** (2006.01); **B65D 81/34** (2006.01)

CPC (source: EP)
B65D 77/225 (2013.01); **B65D 81/3261** (2013.01); **B65D 81/3461** (2013.01); **B65D 2203/12** (2013.01); **B65D 2581/345** (2013.01); **B65D 2581/3464** (2013.01); **B65D 2581/3466** (2013.01); **B65D 2581/3474** (2013.01); **B65D 2581/3477** (2013.01); **B65D 2581/3479** (2013.01); **B65D 2581/3483** (2013.01); **B65D 2581/3494** (2013.01)

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Designated contracting state (EPC)
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IS IT LI LT LU LV MC NL PL PT RO SE SI SK TR

Designated extension state (EPC)
AL BA HR MK YU

DOCDB simple family (publication)
EP 1714908 A2 20061025; EP 1714908 A3 20061108; EP 1714908 B1 20090311; AT 502142 A1 20070115; AT 502142 B1 20070715; AT E425102 T1 20090315; CY 1110257 T1 20150114; DE 502006003051 D1 20090423; DK 1714908 T3 20090427; ES 2320479 T3 20090522; PL 1714908 T3 20090930; PT 1714908 E 20090408; SI 1714908 T1 20090831

DOCDB simple family (application)
EP 06008047 A 20060419; AT 06008047 T 20060419; AT 6722005 A 20050421; CY 091100589 T 20090603; DE 502006003051 T 20060419; DK 06008047 T 20060419; ES 06008047 T 20060419; PL 06008047 T 20060419; PT 06008047 T 20060419; SI 200630304 T 20060419